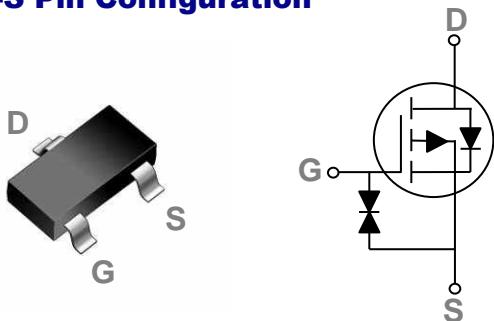


General Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

SOT23-S Pin Configuration



| BVDSS | RDSON | ID |
|-------|-------|-----|
| -20V | 600mΩ | -1A |

Features

- -20V, -1A, $RDS(ON) = 600m\Omega @ VGS = -4.5V$
- Improved dv/dt capability
- Fast switching
- Green Device Available
- Suit for -1.5V Gate Drive Applications

Applications

- Notebook
- Load Switch
- Battery Protection
- Hand-held Instruments

Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

| Symbol | Parameter | Rating | Units |
|-----------|---|------------|----------------|
| V_{DS} | Drain-Source Voltage | -20 | V |
| V_{GS} | Gate-Source Voltage | ± 8 | V |
| I_D | Drain Current – Continuous ($T_A=25^\circ C$) | -1 | A |
| | Drain Current – Continuous ($T_A=70^\circ C$) | -0.8 | A |
| I_{DM} | Drain Current – Pulsed ¹ | -4 | A |
| P_D | Power Dissipation ($T_A=25^\circ C$) | 1 | W |
| | Power Dissipation – Derate above $25^\circ C$ | 8 | mW/ $^\circ C$ |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ C$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^\circ C$ |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--|------|------|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | --- | 125 | $^\circ C/W$ |



20V P-Channel MOSFETs

PDEN2319S

Electrical Characteristics (T_J=25 °C, unless otherwise noted)**Off Characteristics**

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------------|---|---|------|-------|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =-250μA | -20 | --- | --- | V |
| △BV _{DSS} /△T _J | BV _{DSS} Temperature Coefficient | Reference to 25°C, I _D =-1mA | --- | -0.01 | --- | V/°C |
| I _{DSS} | Drain-Source Leakage Current | V _{DS} =-20V, V _{GS} =0V, T _J =25°C | --- | --- | -1 | uA |
| | | V _{DS} =-16V, V _{GS} =0V, T _J =125°C | --- | --- | -10 | uA |
| I _{GSS} | Gate-Source Leakage Current | V _{GS} =±8V, V _{DS} =0V | --- | --- | ±20 | uA |

On Characteristics

| | | | | | | |
|----------------------|---|---|------|------|------|-------|
| R _{DSON} | Static Drain-Source On-Resistance | V _{GS} =-4.5V, I _D =-0.3A | --- | 440 | 600 | mΩ |
| | | V _{GS} =-2.5V, I _D =-0.2A | --- | 610 | 850 | |
| | | V _{GS} =-1.8V, I _D =-0.1A | --- | 810 | 1200 | |
| | | V _{GS} =-1.5V, I _D =-0.1A | --- | 1020 | 1600 | |
| | | V _{GS} =-1.2V, I _D =-0.1A | --- | 1800 | 3000 | |
| V _{GS(th)} | Gate Threshold Voltage | V _{GS} =V _{DS} , I _D =-250μA | -0.3 | -0.6 | -1.0 | V |
| △V _{GS(th)} | V _{GS(th)} Temperature Coefficient | | --- | 3 | --- | mV/°C |

Dynamic and switching Characteristics

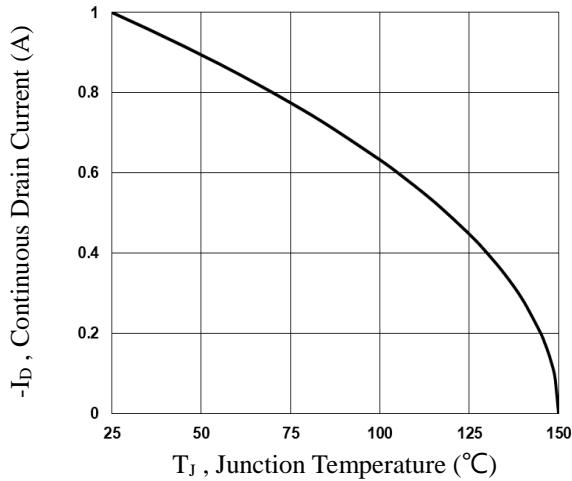
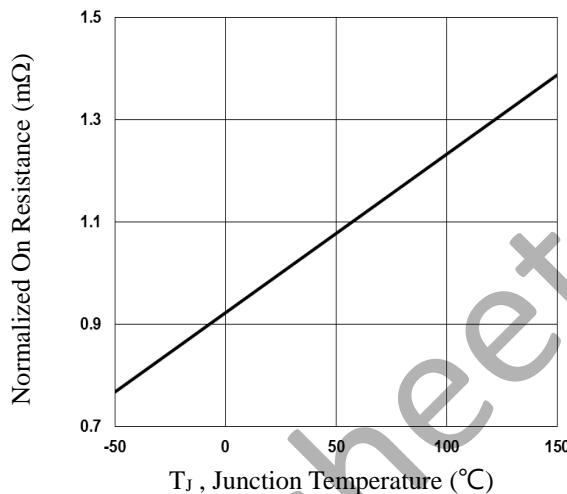
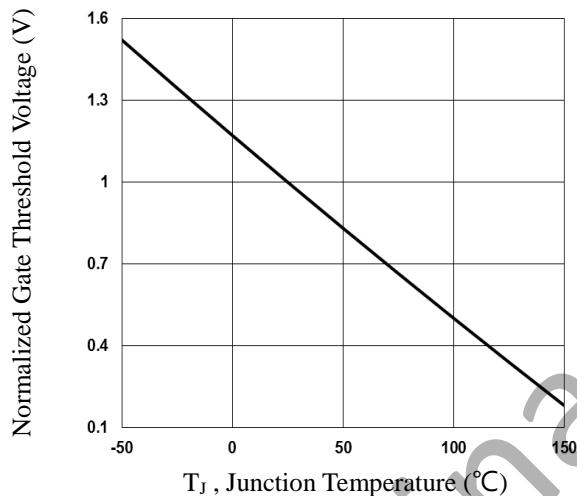
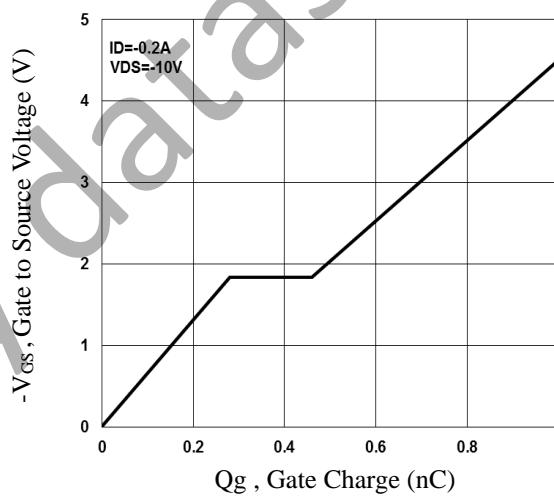
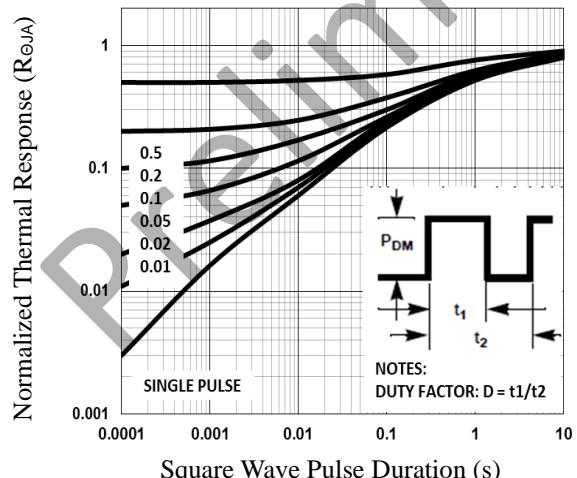
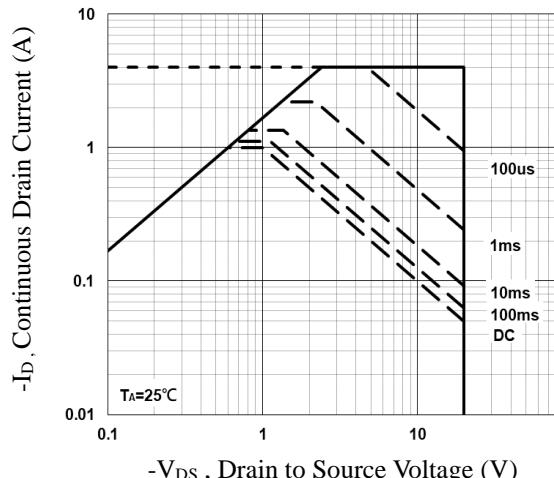
| | | | | | | |
|---------------------|-------------------------------------|---|-----|------|-----|----|
| Q _g | Total Gate Charge ^{2, 3} | V _{DS} =-10V, V _{GS} =-4.5V, I _D =-0.2A | --- | 1 | 2 | nC |
| Q _{gs} | Gate-Source Charge ^{2, 3} | | --- | 0.28 | 0.5 | |
| Q _{gd} | Gate-Drain Charge ^{2, 3} | | --- | 0.18 | 0.4 | |
| T _{d(on)} | Turn-On Delay Time ^{2, 3} | V _{DD} =-10V, V _{GS} =-4.5V, R _G =10Ω I _D =-0.2A | --- | 8 | 16 | ns |
| T _r | Rise Time ^{2, 3} | | --- | 5.2 | 10 | |
| T _{d(off)} | Turn-Off Delay Time ^{2, 3} | | --- | 30 | 60 | |
| T _f | Fall Time ^{2, 3} | | --- | 18 | 36 | |
| C _{iss} | Input Capacitance | | --- | 40 | 78 | pF |
| C _{oss} | Output Capacitance | V _{DS} =-10V, V _{GS} =0V, F=1MHz | --- | 15 | 30 | |
| C _{rss} | Reverse Transfer Capacitance | | --- | 6.5 | 13 | |

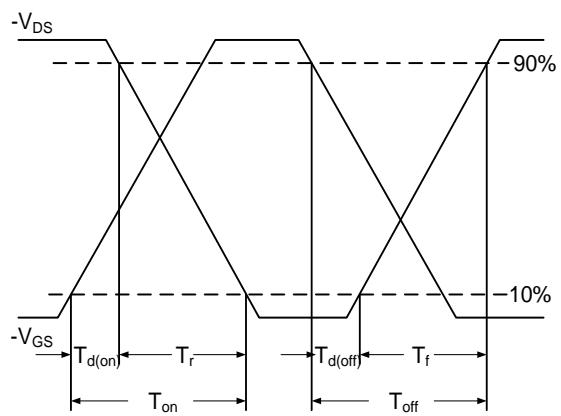
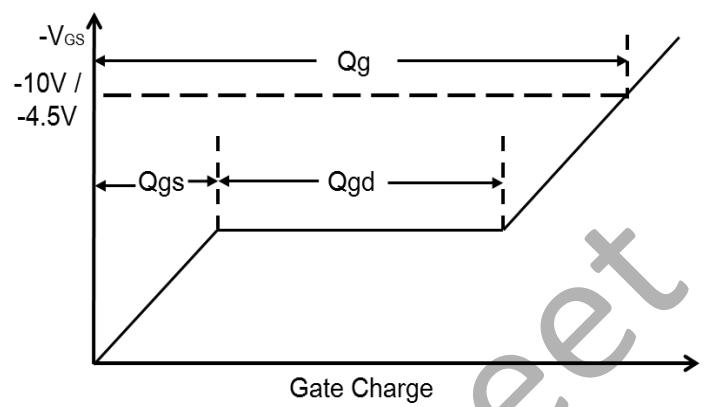
Drain-Source Diode Characteristics and Maximum Ratings

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-----------------|---------------------------|--|------|------|------|------|
| I _s | Continuous Source Current | V _G =V _D =0V, Force Current | --- | --- | -1 | A |
| I _{SM} | Pulsed Source Current | | --- | --- | -2 | A |
| V _{SD} | Diode Forward Voltage | V _{GS} =0V, I _s =-0.2A, T _J =25°C | --- | --- | -1 | V |

Note :

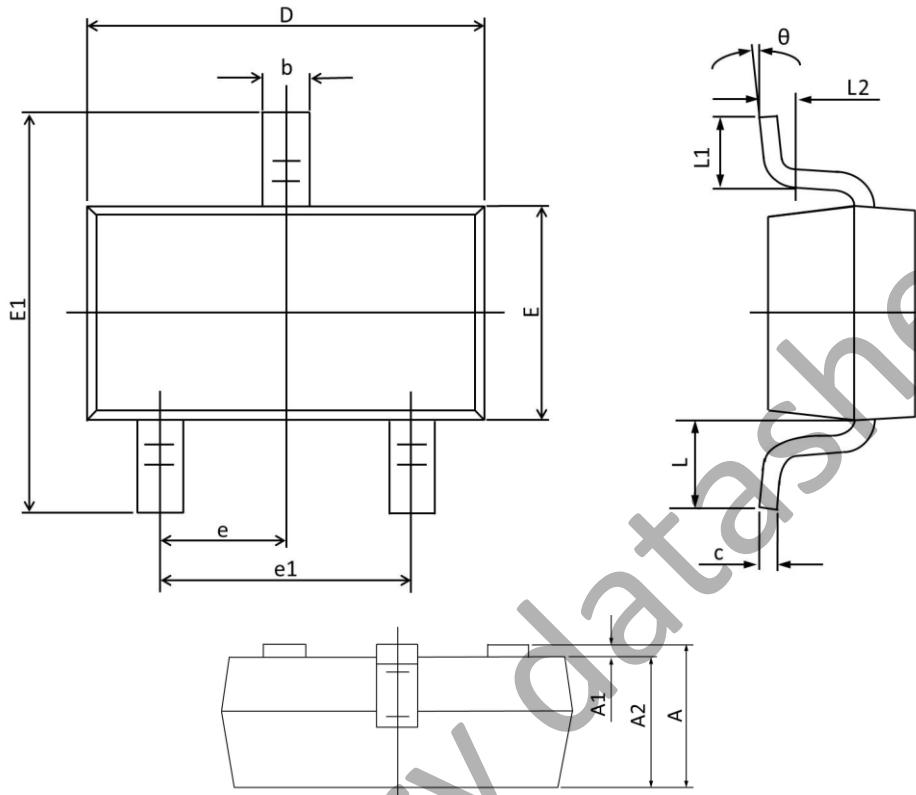
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. Essentially independent of operating temperature.


Fig.1 Continuous Drain Current vs. T_J

Fig.2 Normalized RD_{SON} vs. T_J

Fig.3 Normalized V_{th} vs. T_J

Fig.4 Gate Charge Waveform

Fig.5 Normalized Transient Response

Fig.6 Maximum Safe Operation Area


Fig.7 Switching Time Waveform

Fig.8 Gate Charge Waveform

Preliminary datasheet

SOT23-3S PACKAGE INFORMATION



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Max | Min | Max | Min |
| A | 1.150 | 0.900 | 0.045 | 0.035 |
| A1 | 0.100 | 0.000 | 0.004 | 0.000 |
| A2 | 1.050 | 0.900 | 0.041 | 0.035 |
| b | 0.500 | 0.300 | 0.020 | 0.012 |
| c | 0.150 | 0.080 | 0.006 | 0.003 |
| D | 3.000 | 2.800 | 0.118 | 0.110 |
| E | 1.400 | 1.200 | 0.055 | 0.047 |
| E1 | 2.550 | 2.250 | 0.100 | 0.089 |
| e | 0.95 TYP. | | 0.037 TYP. | |
| e1 | 2.000 | 1.800 | 0.079 | 0.071 |
| L | 0.55 REF. | | 0.022 REF. | |
| L1 | 0.500 | 0.300 | 0.020 | 0.012 |
| L2 | 0.25 TYP. | | 0.01 TYP. | |
| theta | 8° | 0° | 8° | 0° |